

# SLF60R065E7 / SLH60R065E7

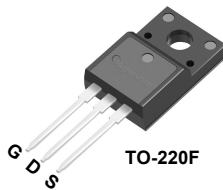
## 600V N-Channel Multi-EPI Super-JMOSFET

### General Description

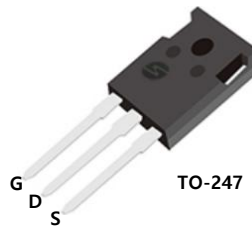
This Power MOSFET is produced using Maple semi's advanced Superjunction MOSFET technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies.

### Features

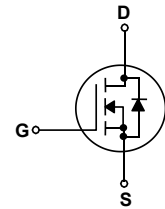
- 50A, 600V,  $R_{DS(on)Typ} = 53m\Omega @ V_{GS} = 10V$
- Low gate charge (typ.  $Q_g = 75nC$ )
- High ruggedness Ultra
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



TO-220F



TO-247



### Absolute Maximum Ratings

$T_C = 25^\circ C$  unless otherwise noted

Symbol	Parameter	SLF60R065E7 / SLH60R065E7	Units
$V_{DSS}$	Drain-Source Voltage	600	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ C$ ) - Continuous ( $T_C = 100^\circ C$ )	50*	A
		27.2*	A
$I_{DM}$	Drain Current - Pulsed (Note 1)	129 *	A
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
EAS	Single Pulsed Avalanche Energy (Note 2)	281	mJ
$I_{AR}$	Avalanche Current (Note 1)	6.6	A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	3.29	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	20	V/ns
	MOSFET dv/dt	100	
$P_D$	Power Dissipation ( $T_C = 25^\circ C$ ) - Derate above $25^\circ C$	48	329
		0.38	2.63
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	260	$^\circ C$

\* Drain current limited by maximum junction temperature.

### Thermal Characteristics

Symbol	Parameter	SLF60R065E7 / SLH60R065E7	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	2.6	0.38
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink Typ.	-	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	40

## Package Marking

Part Number	Top Marking	Package	Packing Method	MOQ	QTY
SLF60R065E7	SLF60R065E7	T0-220F	Tube	1000	5000
SLH60R065E7	SLH60R090E7	T0-247	Tube	450	2250

## Electrical Characteristics

$T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### Off Characteristics

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\mu\text{A}$	600	--	--	V
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\mu\text{A}, T_J = 150^\circ\text{C}$	650	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 480\text{ V}, T_C = 125^\circ\text{C}$	--	2.1	--	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA

### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.5	--	4.5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 25\text{ A}$	--	53	70	m $\Omega$

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 400\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	--	3208	--	pF
$C_{oss}$	Output Capacitance		--	81	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	--	--	pF

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DS} = 400\text{ V}, I_D = 25\text{ A}, R_G = 10\ \Omega, V_{GS} = 10\text{ V}$ (Note 4, 5)	--	17	--	ns
$t_r$	Turn-On Rise Time		--	8	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	71	--	ns
$t_f$	Turn-Off Fall Time		--	9	--	ns
$Q_g$	Total Gate Charge	$V_{DS} = 400\text{ V}, I_D = 25\text{ A}, V_{GS} = 10\text{ V}$ (Note 4, 5)	--	75	--	nC
$Q_{gs}$	Gate-Source Charge		--	17.2	--	nC
$Q_{gd}$	Gate-Drain Charge		--	34.5	--	nC
$R_G$	Gate Resistance	$f = 1\text{ MHz}$		1.3		$\Omega$

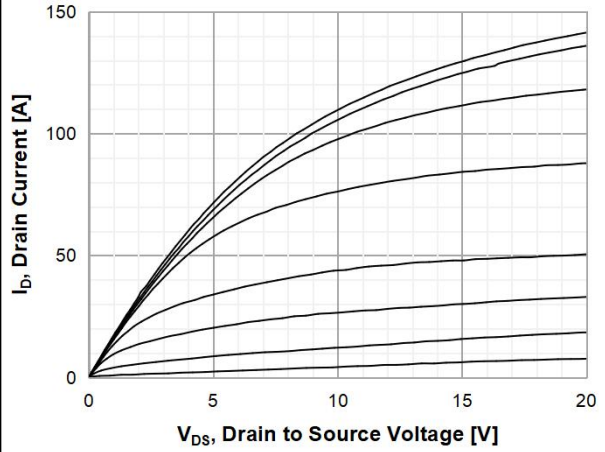
### Drain-Source Diode Characteristics and Maximum Ratings

$I_S$	Maximum Continuous Drain-Source Diode Forward Current	--	--	50	A	
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current	--	--	129	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 25\text{ A}$	--	--	1.2	V
$t_{rr}$	Reverse Recovery Time	$V_{DD} = 400\text{ V}, I_S = 25\text{ A}, dI_F / dt = 100\text{ A}/\mu\text{s}$ (Note 4)	--	413	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	7.2	--	$\mu\text{C}$

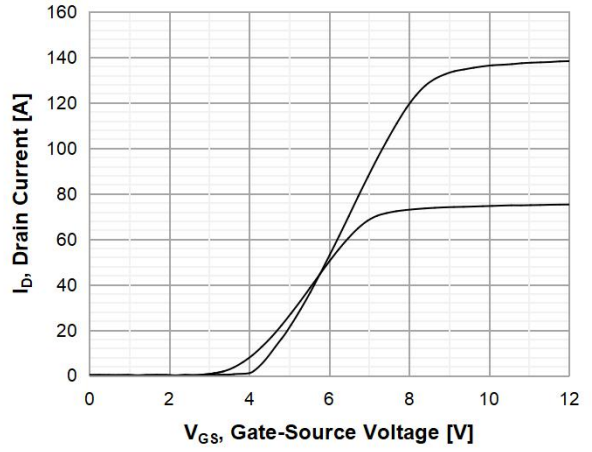
#### Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $I_{AS} = 6.6\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} \leq 21.5\text{ A}, dI/dt \leq 100\text{ A}/\mu\text{s}, V_{DD} \leq 400$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$
5. Essentially independent of operating temperature

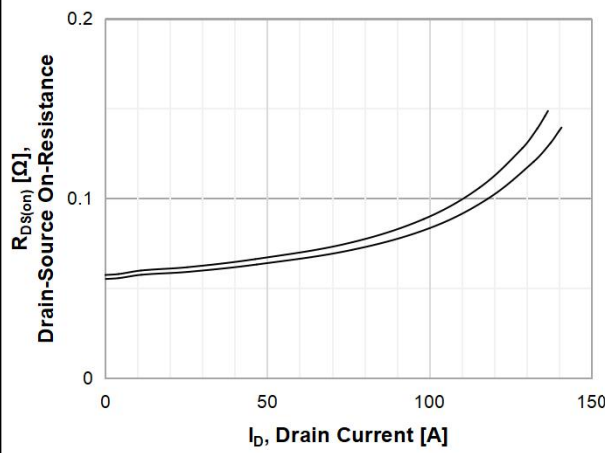
**Typical Characteristics**



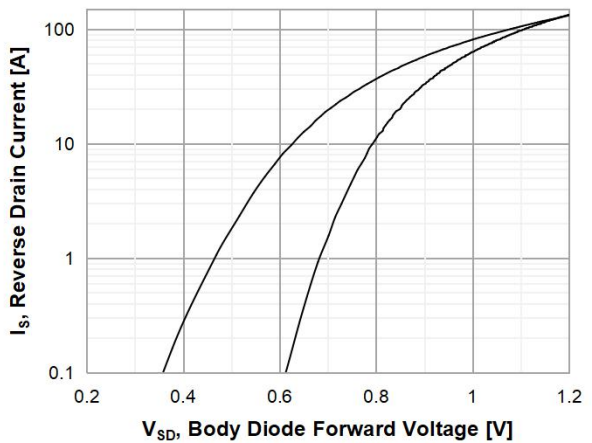
**Figure 1. On-Region Characteristics**



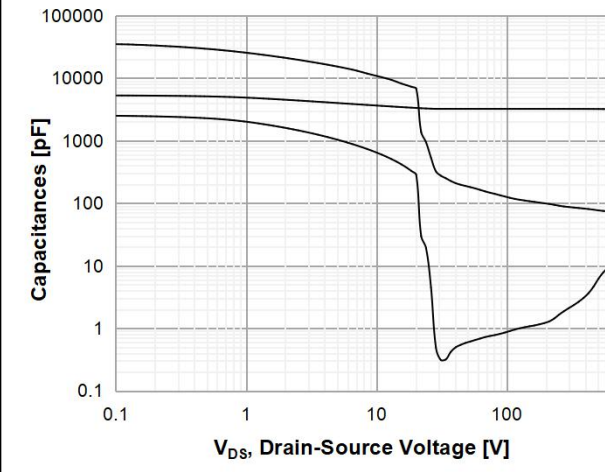
**Figure 2. Transfer Characteristics**



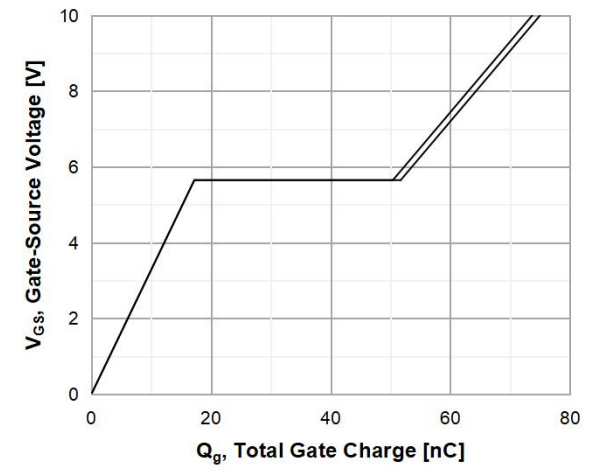
**Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**

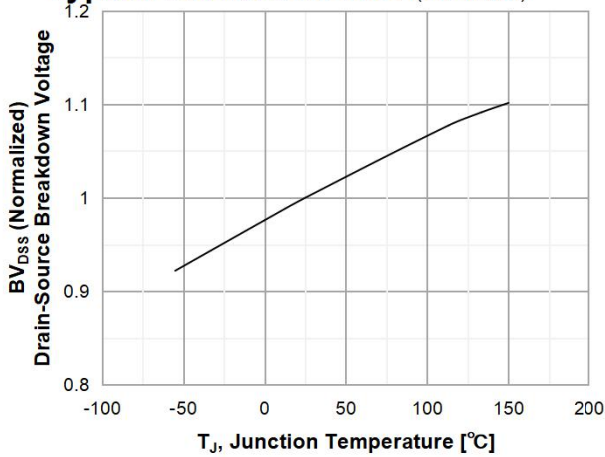


**Figure 5. Capacitance Characteristics**

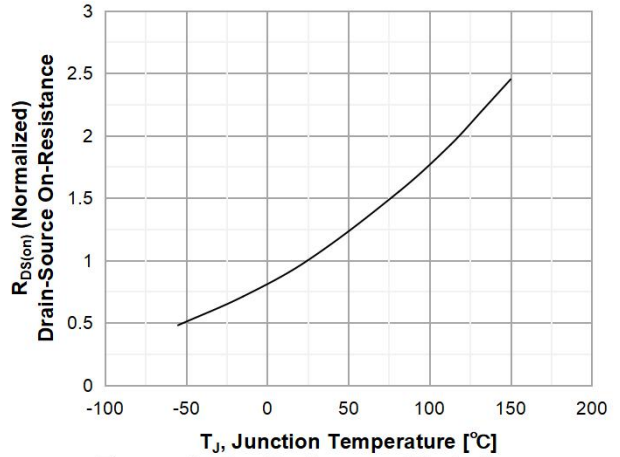


**Figure 6. Gate Charge Characteristics**

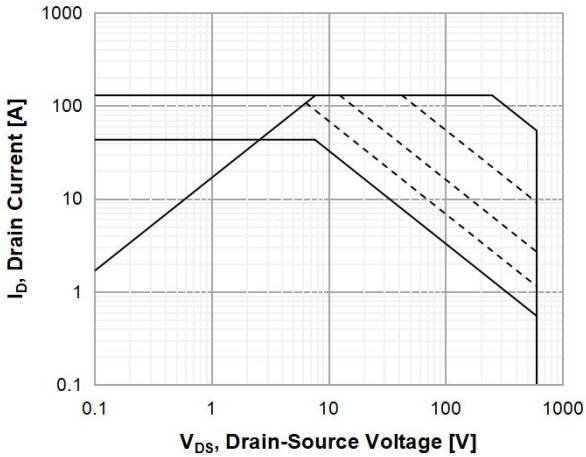
**Typical Characteristics** (Continued)



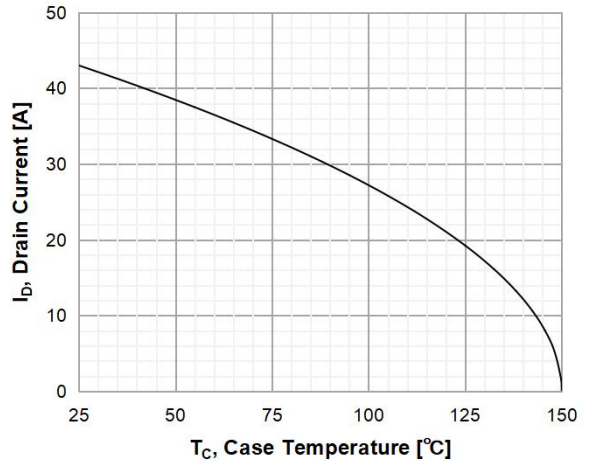
**Figure 7. Breakdown Voltage Variation vs Temperature**



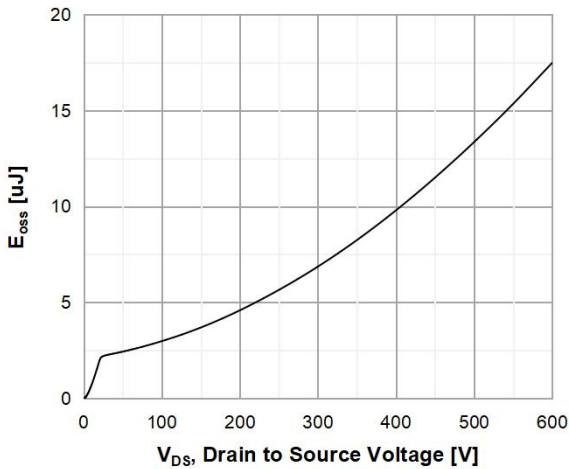
**Figure 8. On-Resistance Variation vs Temperature**



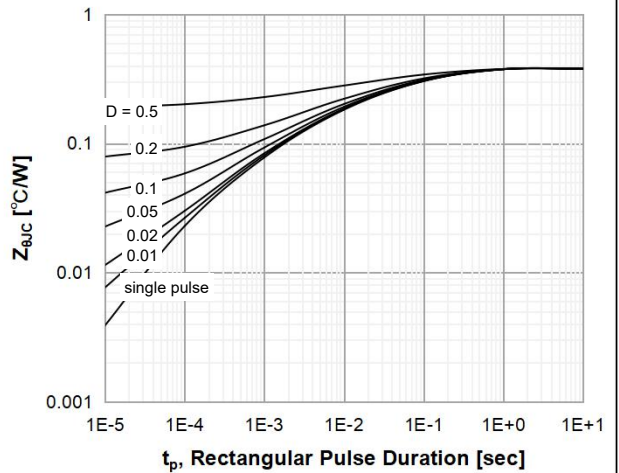
**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**

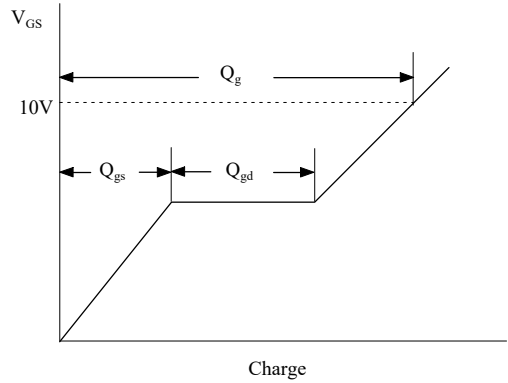


**Figure 11. E<sub>oss</sub> vs. Drain to Source Voltage**

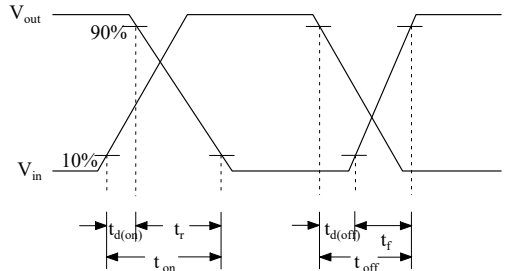
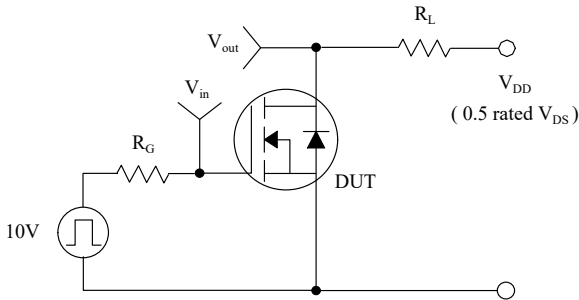


**Figure 12. Transient Thermal Response Curve**

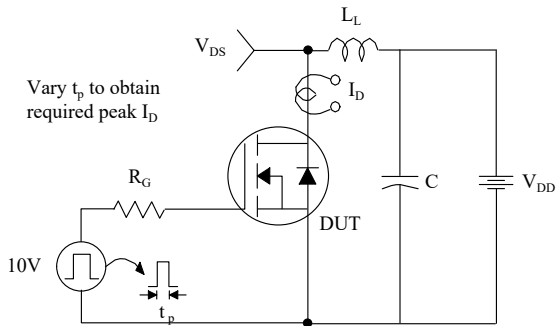
### Gate Charge Test Circuit & Waveform



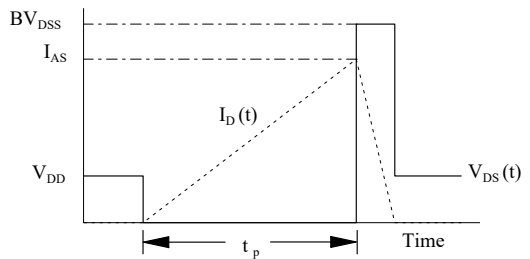
### Resistive Switching Test Circuit & Waveforms



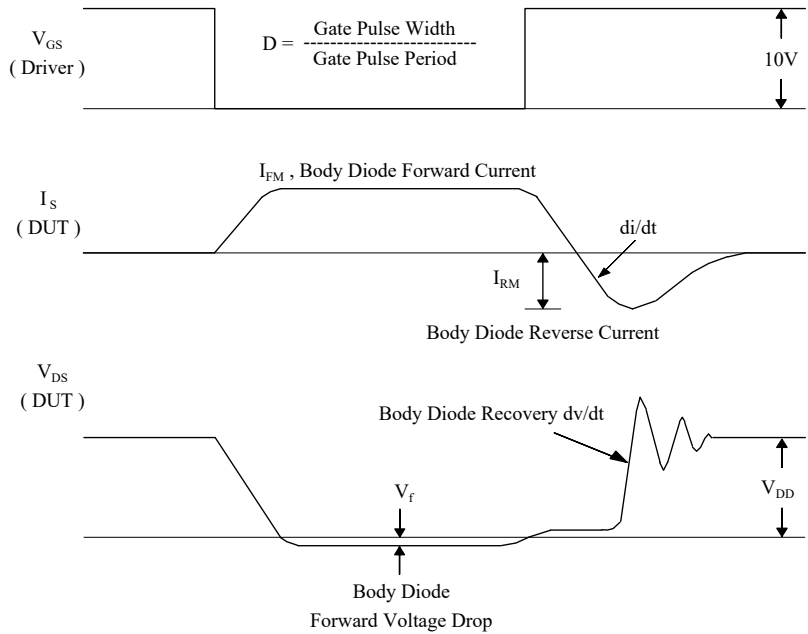
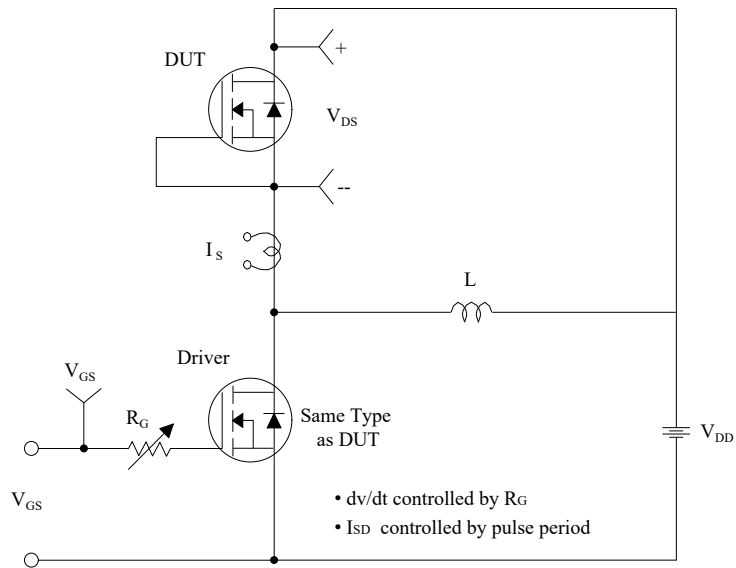
### Unclamped Inductive Switching Test Circuit & Waveforms



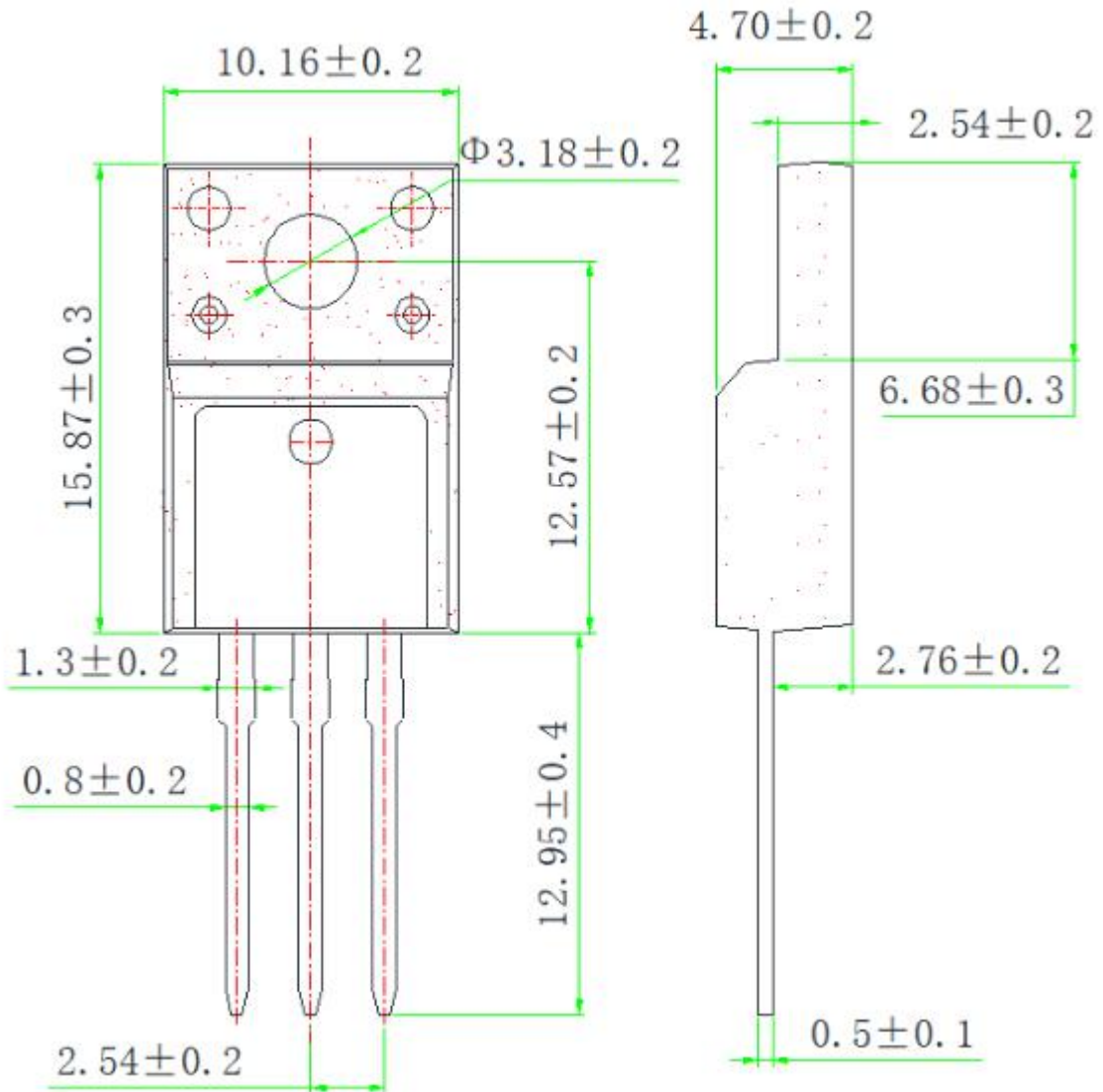
$$E_{AS} = \frac{1}{2} L_L I_{AS}^2$$



### Peak Diode Recovery dv/dt Test Circuit & Waveforms



## TO-220F OUTLINE

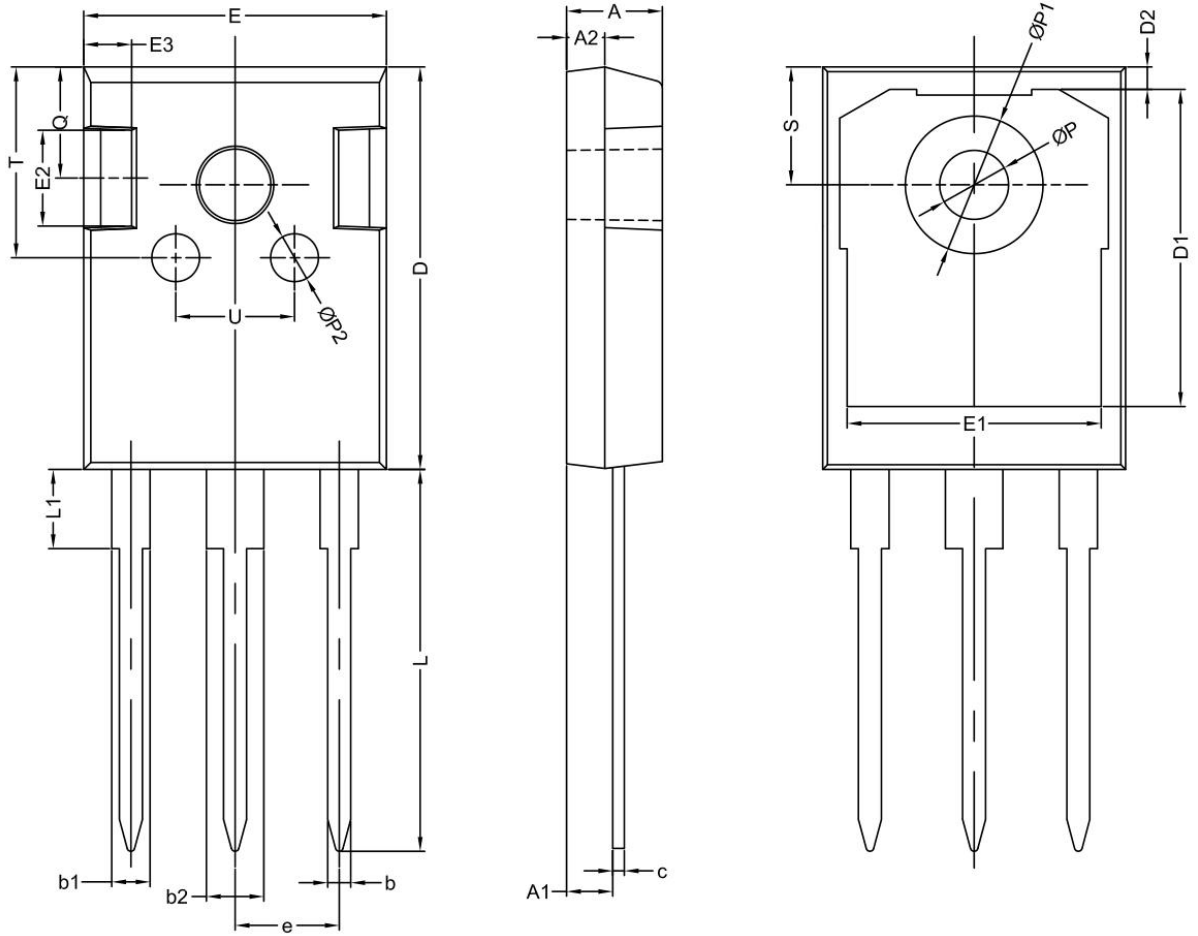


## NOTE:

1 The plastic package is not marked as smooth surface  $R_a = 0.1$ ; Subglossy surface  $R_a = 0.8$

2. Undeclared tolerance  $\pm 0.25$ , Unmarked fillet  $R_{max} = 0.25$

### TO-247 OUTLINE



SYMBOL	Mechanical Dimensions/mm			SYMBOL	Mechanical Dimensions/mm			SYMBOL	Mechanical Dimensions/mm		
	MIN	NOM	MAX						MIN	NOM	MAX
A	4.80	5.00	5.20	D	20.80	21.00	21.20	L1	-	4.13	-
A1	2.21	2.41	2.61	D1	-	16.55	-	Ø P	3.5	3.6	3.7
A2	1.90	2.00	2.10	E	15.60	15.80	16.0	Ø P1	-	-	7.40
b	1.10	1.20	1.35	E1		13.3		Ø P2	-	2.50	-
b1	-	2.00	-	E2		5.0		Q	-	5.8	-
b2	-	3.00	-	e	5.44			S	6.05	6.15	6.25
c	0.55	0.60	0.75	L	19.42	19.92	20.42	T	-	10.0	-

**NOTE:**

1The plastic package is not marked as smooth surfaceRa=0.1;Subglossy surfaceRa=0.8

2.Undeclared tolerance ±0.25,Unmarked filletRmax=0.25